2SC3063

Silicon NPN triple diffusion planar type

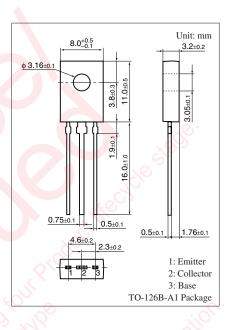
For TV video output amplification

Features

- High collector-emitter voltage (Base open) V_{CEO}
- \bullet Small collector output capacitance (Common base, input open circuited) C_{ob}
- TO-126B package which requires no insulation plate for installation to the heat sink

Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	V _{CBO}	300	V
Collector-emitter voltage (Base open)	V _{CEO}	300	V
Emitter-base voltage (Collector open)	V _{EBO}	7	V
Collector current	I _C	100	mA
Peak collector current	I _{CP}	200	mA
Collector power dissipation	P _C	1.2	W
Junction temperature	Tj	150	°C
Storage temperature	T _{stg}	-55 to +150	°C

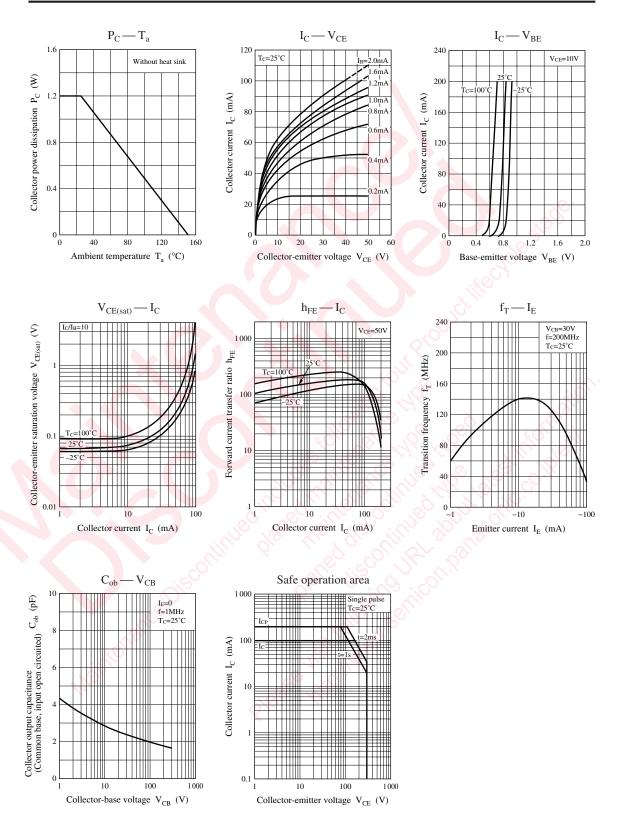


Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V _{CBO}	$I_{\rm C} = 10 \ \mu A, I_{\rm E} = 0$	300	S		V
Collector-emitter voltage (Base open)	V _{CEO}	$I_{\rm C} = 0.1 \text{ mA}, I_{\rm B} = 0$	300	0		V
Emitter-base voltage (Collector open)	V _{EBO}	$I_{\rm E} = 10 \ \mu A, I_{\rm C} = 0$	7			V
Base-emitter voltage	V _{BE}	$V_{CE} = 10 \text{ V}, I_C = 30 \text{ mA}$			1.2	V
Forward current transfer ratio	h _{FE}	$V_{CE} = 50 \text{ V}, I_C = 5 \text{ mA}$	50		250	
Collector-emitter saturation voltage	V _{CE(sat)}	$I_{\rm C} = 30 \text{ mA}, I_{\rm B} = 3 \text{ mA}$			1.5	V
Transition frequency	f _T	$V_{CB} = 30 \text{ V}, I_E = -20 \text{ mA}, f = 200 \text{ MHz}$	70	140		MHz
Collector output capacitance (Common base, input open circuited)	C _{ob}	$V_{CB} = 30 V, I_E = 0, f = 1 MHz$		2.4		pF

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

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